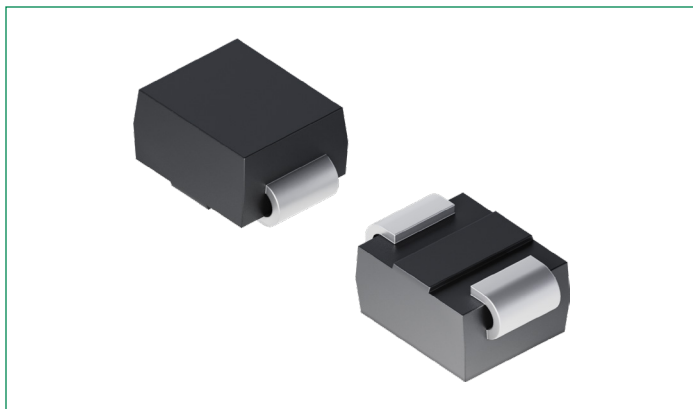


DS1002S2ARP

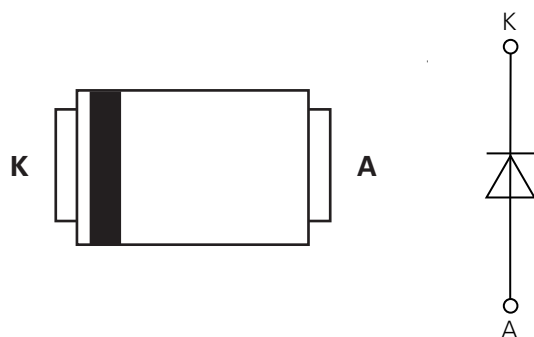
2 A Silicon Schottky Barrier Diode

RoHS

AUTOMOTIVE GRADE



Pinout Diagram (DO-214AA)

**A:** Anode; **K:** Cathode

Description

These silicon Schottky Barrier Diodes are based on a metal-to-silicon junction principle in power rectifier design, resulting in a very low forward voltage drop and stable electrical performance. The devices are assembled in a DO-214AA package, which is well suited for automated assembly processes. In addition, all devices are PPAP Level 3 compliant, supporting automotive qualification requirements.

Features

- Reverse leakage current $I_R \leq 1 \mu\text{A} @ 25^\circ\text{C}$
- Forward voltage $V_F \leq 0.79 \text{ V} @ 2 \text{ A}$
- DO-214AA package
- Maximum virtual junction temperature of 175°C
- AEC-Q101 qualified
- PPAP capable

Benefits

- Reduces the PCB area and ideal for automated assembly
- Higher current in the same package
- High efficiency
- Low stand-by losses
- Ensures compliance with automotive industry standards

Applications

- Switch Mode Power Supplies (SMPS)
- Freewheeling diodes
- Reverse battery polarity protection
- DC-DC converter

Product Summary

Characteristic	Value	Unit
V_{RRM}	100	V
$I_{F(AV)}$	2	A

Maximum Ratings

Symbol	Characteristics	Conditions	Value	Units
V_{RRM}	Repetitive Peak Reverse Voltage	$T_{vj} = 25\text{ }^{\circ}\text{C}$	100	V
$I_{F(AV)}$	Average Forward Current	$T_L = 150\text{ }^{\circ}\text{C}$	2	A
I_{FSM}	Non-repetitive Surge Forward Current	Single half cycle; $f = 50\text{ Hz}$; $T_{vj}(\text{initial}) = 25\text{ }^{\circ}\text{C}$	150	A
		Single half cycle; $f = 60\text{ Hz}$; $T_{vj}(\text{initial}) = 25\text{ }^{\circ}\text{C}$	165	
T_{vj}	Virtual Junction Temperature Range	–	–40 to +175	$^{\circ}\text{C}$
T_{stg}	Storage Temperature Range	–	–65 to +175	$^{\circ}\text{C}$
I^2t	I^2t Value	$t_p = 8.3\text{ ms}$, $T_{vj} = 25\text{ }^{\circ}\text{C}$	113	A^2s

Static Characteristics

Symbol	Characteristics	Conditions	Value			Units
			Min.	Typ.	Max.	
V_F	Forward Voltage	$I_F = 2\text{ A}$, $T_{vj} = 25\text{ }^{\circ}\text{C}$,	–	–	0.79	V
I_R	Reverse Current	$V_R = V_{RRM}$, $T_{vj} = 25\text{ }^{\circ}\text{C}$	–	–	1	μA
		$T_{vj} = 125\text{ }^{\circ}\text{C}$	–	–	1	mA
$V_{(TO)}$	Threshold Voltage	$T_{vj} = 175\text{ }^{\circ}\text{C}$	–	–	0.41	V
r_T	Slope Resistance	$T_{vj} = 175\text{ }^{\circ}\text{C}$	–	–	33	$\text{m}\Omega$

Thermal Specifications

Symbol	Characteristics	Value	Unit
$R_{th(j-l)}$	Thermal Resistance, Junction to Lead	20	K/W
$R_{th(j-a)}$	Thermal Resistance, Junction to Ambient	80	K/W

Note: Mounted on a 1S1P 1" square FR-4 board, top layer pad size 2.0 mm * 2.2 mm & 2 oz 1" square copper plane

Characteristic Curves

Fig. 1. On-State Current vs. On-State Voltage (Typical)

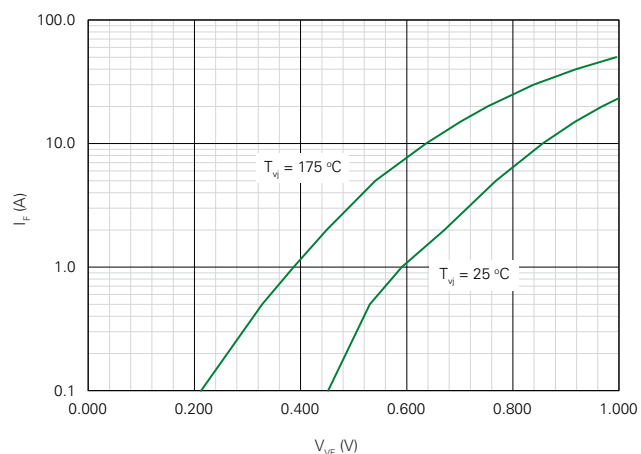


Fig. 2. Power Dissipation vs. Average Forward On-State Current (Typical)

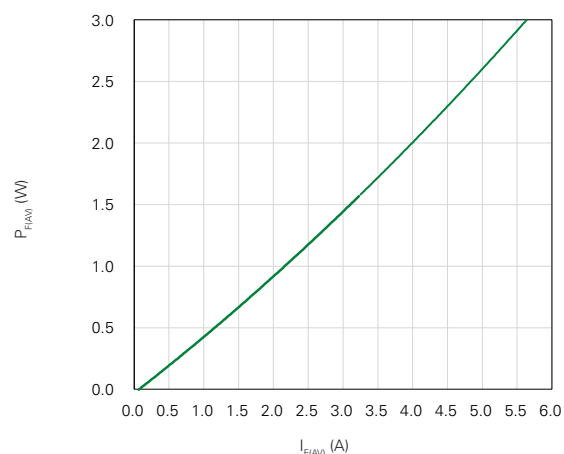


Fig. 3. Maximum Allowable Lead Temperature vs. Average On-State Current

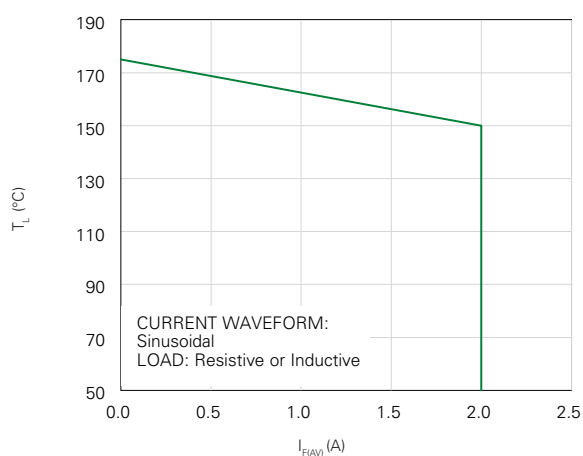


Fig. 4. Junction Capacitance vs. Reverse Voltage

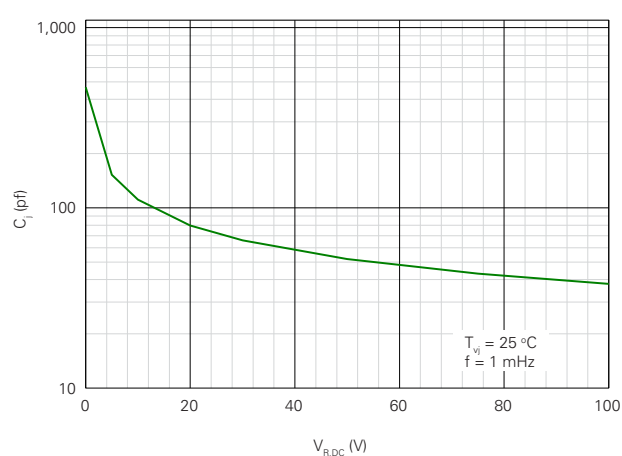
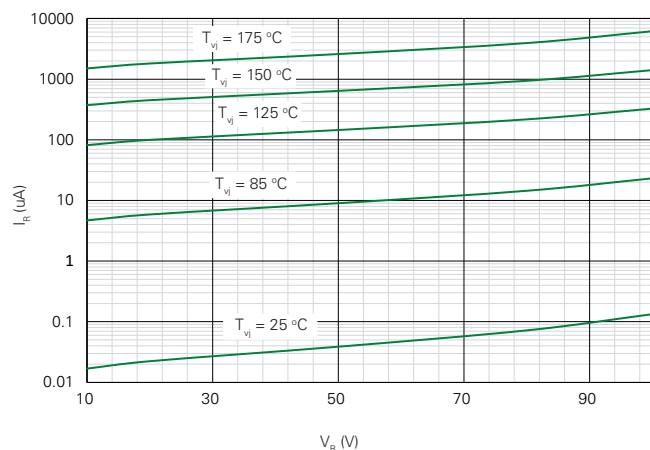
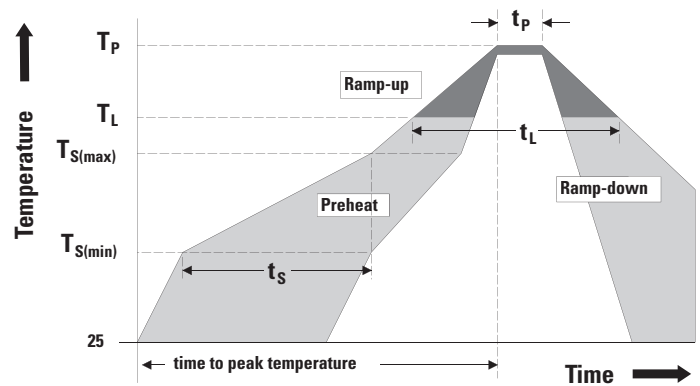


Fig. 5. Typical Reverse Characteristics



Soldering Parameters

Characteristic		Value
Reflow Condition		Pb – free assembly
Pre-heat	Temperature Min ($T_{s(min)}$)	150 °C
	Temperature Max ($T_{s(max)}$)	200 °C
	Time (min to max) (t_s)	60 – 120 secs
Average ramp up rate (Liquidus Temp) (T_L) to peak		3 K/s max.
$T_{s(max)}$ to T_L - Ramp-up Rate		3 K/s max.
Reflow	Temperature (T_L) (Liquidus)	217 °C
	Time (t_L)	60 – 150 seconds
Peak Temperature (T_p)		260 ^{+0/-5} °C
Time within 5 °C of actual peak Temperature (t_p)		30 seconds
Ramp-down Rate		6 K/s max.
Time 25 °C to peak Temperature (T_p)		8 minutes max.
Do Not Exceed		260 °C



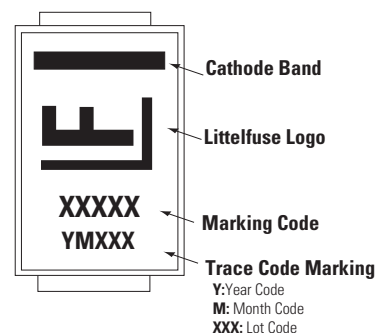
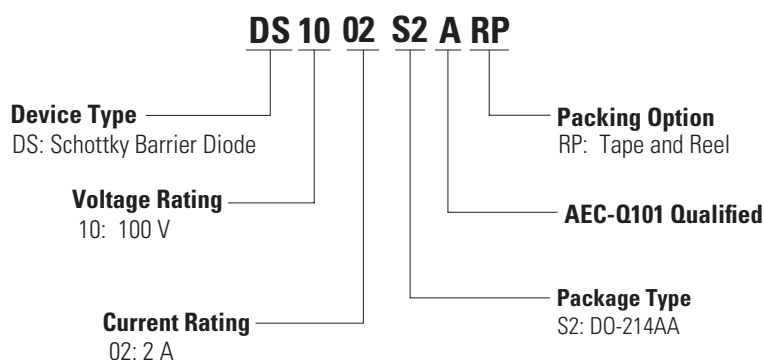
Physical Specifications

Characteristic	Value
Terminal Finish	100% Matte Tin-plated
Body Material	UL recognized epoxy meeting flammability rating V-0
Terminal Material	Copper Alloy

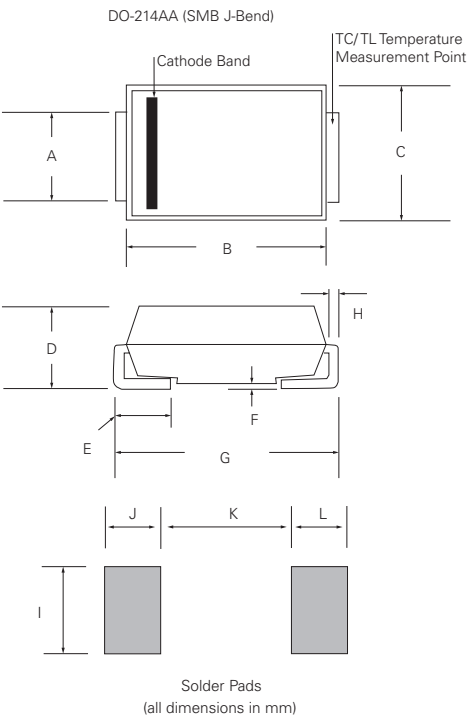
Packing Options

Part Number	Marking	Package	Packing Mode	Base Quantity
DS1002S2ARP	SA02A	DO-214AA	Tape and Reel – 16 mm tape/ 13" reel	3000

Part Numbering and Marking

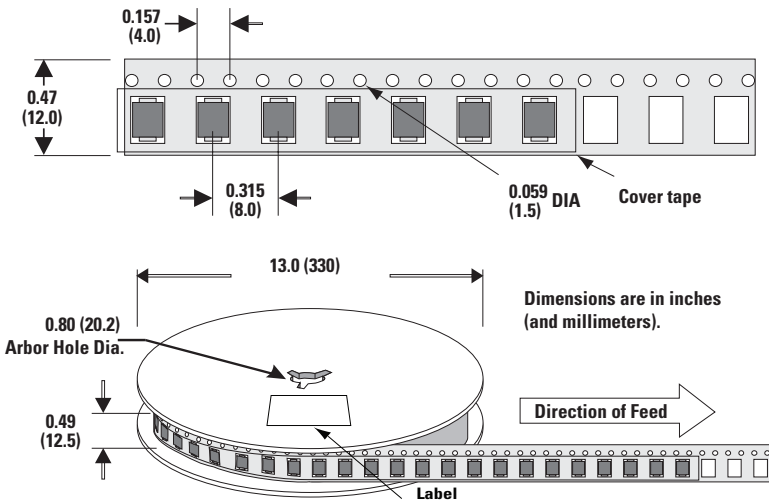


Package Dimensions DO-214AA



Symbol	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	1.950	2.200	0.077	0.086
B	4.060	4.570	0.160	0.180
C	3.300	3.940	0.130	0.155
D	2.130	2.440	0.084	0.096
E	0.760	1.520	0.030	0.060
F	–	0.203	–	0.008
G	5.210	5.590	0.205	0.220
H	0.152	0.305	0.006	0.012
I	2.260	–	0.089	–
J	2.160	–	0.085	–
K	–	2.740	–	0.107
L	2.160	–	0.085	–

Tape and Reel Specification



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